

## FX6KMJ-06

# High-Speed Switching Use Pch Power MOS FET

REJ03G0261-0100 Rev.1.00 Aug.20.2004

### **Features**

• Drive voltage: 4 V

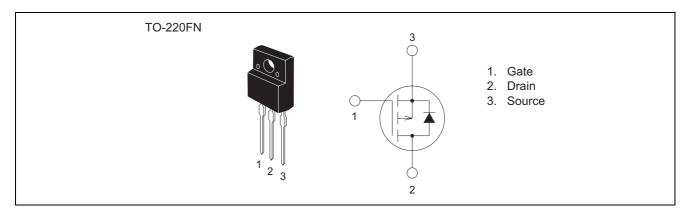
•  $V_{DSS}$ : -60 V

•  $r_{DS(ON) \, (max)}$ : 0.21  $\Omega$ 

•  $I_D: -6 A$ 

• Recovery Time of the Integrated Fast Recovery Diode (TYP.): 50 ns

### **Outline**



## **Applications**

Motor control, lamp control, solenoid control, DC-DC converters, etc.

## **Maximum Ratings**

 $(Tc = 25^{\circ}C)$ 

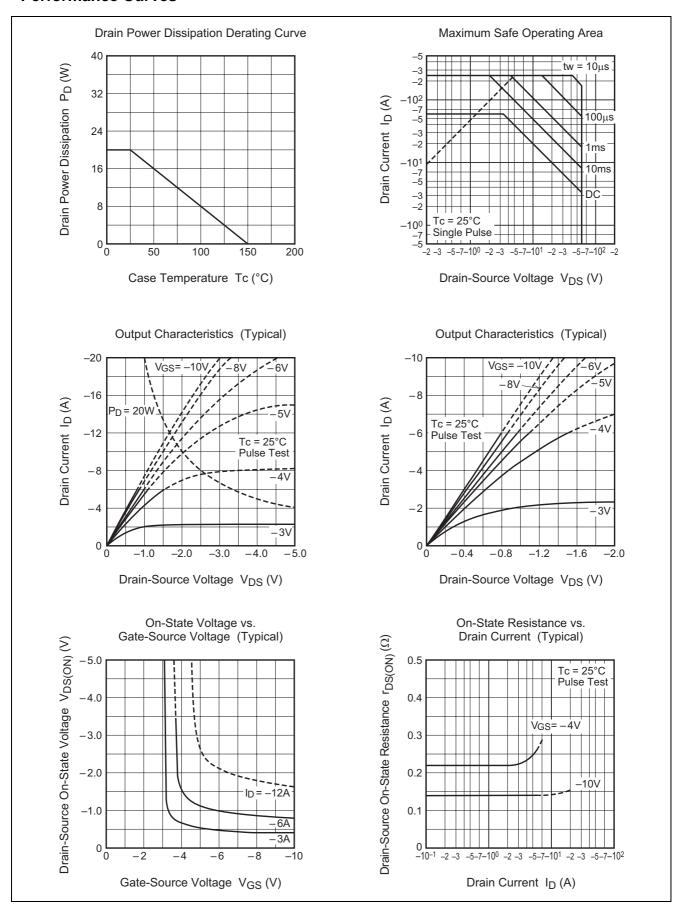
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	V <sub>DSS</sub>	-60	V	V <sub>GS</sub> = 0 V
Gate-source voltage	$V_{GSS}$	±20	V	$V_{DS} = 0 V$
Drain current	I <sub>D</sub>	-6	А	
Drain current (Pulsed)	I <sub>DM</sub>	-24	А	
Avalanche current (Pulsed)	I <sub>DA</sub>	-6	А	L = 100 μH
Source current	Is	-6	А	
Source current (Pulsed)	I <sub>SM</sub>	-24	Α	
Maximum power dissipation	P <sub>D</sub>	20	W	
Channel temperature	Tch	- 55 to +150	°C	
Storage temperature	Tstg	- 55 to +150	°C	
Isolation voltage	Viso	2000	V	AC 1 minute,
				Terminal to case
Mass	_	2.0	g	Typical value

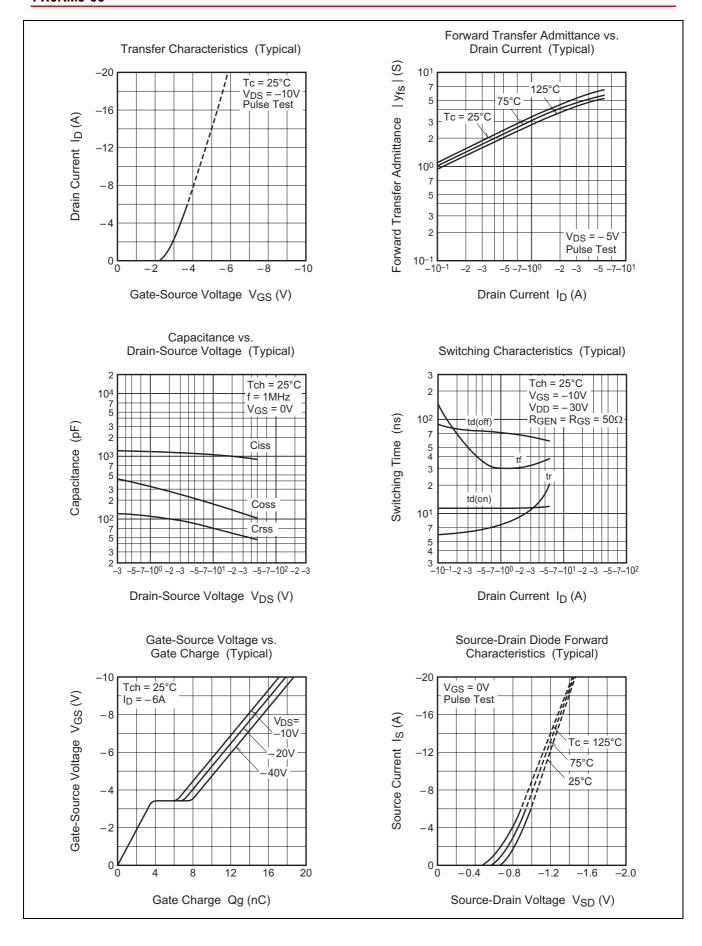
## **Electrical Characteristics**

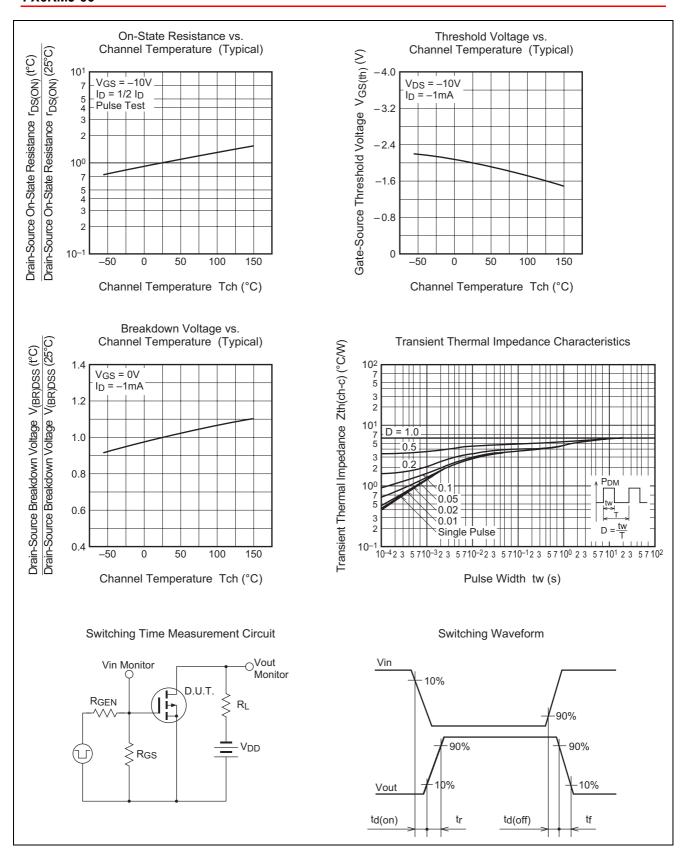
 $(Tch = 25^{\circ}C)$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	-60	_	_	V	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	
Gate-source leakage current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Drain-source leakage current	I <sub>DSS</sub>	_	_	-0.1	mA	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$	
Gate-source threshold voltage	$V_{GS(th)}$	-1.3	-1.8	-2.3	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$	
Drain-source on-state resistance	r <sub>DS(ON)</sub>	1	0.16	0.21	Ω	$I_D = -3 \text{ A}, V_{GS} = -10 \text{ V}$	
Drain-source on-state resistance	r <sub>DS(ON)</sub>	_	0.27	0.37	Ω	$I_D = -3 \text{ A}, V_{GS} = -4 \text{ V}$	
Drain-source on-state voltage	V <sub>DS(ON)</sub>	1	-0.48	-0.63	V	$I_D = -3 \text{ A}, V_{GS} = -10 \text{ V}$	
Forward transfer admittance	y <sub>fs</sub>	1	4.9	_	S	$I_D = -3 A, V_{DS} = -5 V$	
Input capacitance	Ciss	_	1040	_	pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$	
Output capacitance	Coss		171	_	pF	f = 1MHz	
Reverse transfer capacitance	Crss		68	_	pF		
Turn-on delay time	t <sub>d(on)</sub>		13	_	ns	$V_{DD} = -30 \text{ V}, I_{D} = -3 \text{ A},$ $V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$	
Rise time	t <sub>r</sub>		10	_	ns		
Turn-off delay time	t <sub>d(off)</sub>	_	63	_	ns		
Fall time	t <sub>f</sub>		31	_	ns		
Source-drain voltage	$V_{SD}$		-1.0	-1.5	V	$I_S = -3 \text{ A}, V_{GS} = 0 \text{ V}$	
Thermal resistance	Rth(ch-c)			6.25	°C/W	Channel to case	
Reverse recovery time	t <sub>rr</sub>	_	50	_	ns	$I_S = -6 \text{ A}, \text{ dis/dt} = 100 \text{ A/}\mu\text{s}$	

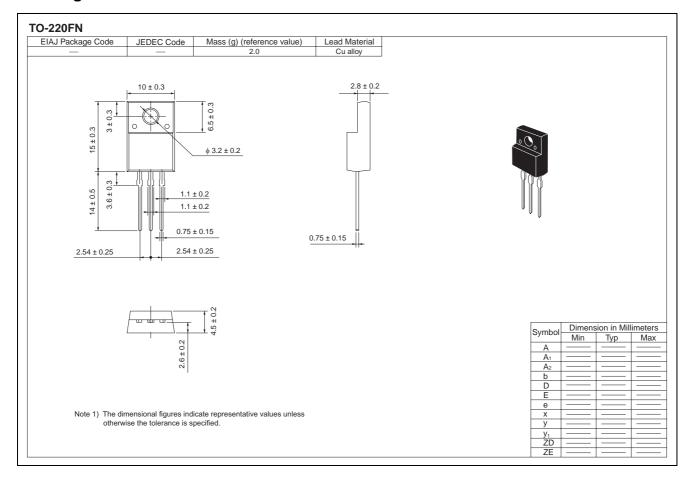
### **Performance Curves**







## **Package Dimensions**



## **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	FX6KMJ-06
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	FX6KMJ-06-A8

Note: Please confirm the specification about the shipping in detail.

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